

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPD60R2K0C6	**Issued**	27. April 2022
MA#	MA005732229		
Package	PG-TO252-3-35	**Weight***	321.91 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.272	0.40	0.40	3950	3950
leadframe	inorganic material	phosphorus	7723-14-0	0.053	0.02		165	
	non noble metal	iron	7439-89-6	0.177	0.06		550	
	non noble metal	copper	7440-50-8	176.899	54.94	55.02	549521	550236
wire	non noble metal	aluminium	7429-90-5	0.669	0.21	0.21	2077	2077
encapsulation	organic material	carbon black	1333-86-4	0.412	0.13		1280	
	plastics	epoxy resin	-	16.072	4.99		49927	
	inorganic material	silicondioxide	60676-86-0	120.885	37.55	42.67	375519	426726
leadfinish	non noble metal	tin	7440-31-5	3.834	1.19	1.19	11908	11908
solder	non noble metal	tin	7440-31-5	0.033	0.01		102	
	noble metal	silver	7440-22-4	0.041	0.01		128	
	non noble metal	lead	7439-92-1	1.569	0.49	0.51	4873	5103
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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